



100V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	RDS(ON)	Package	I _D T _C = +25°C
100V	$8.5 \text{m}\Omega \text{ @V}_{GS} = 10 \text{V}$	TO220AB	101A
100 V	$14m\Omega @V_{GS} = 4.5V$	10220AB	78A

Description

This new generation MOSFET features low on-resistance and fast switching, making it ideal for high-efficiency power management applications.

Applications

- Motor Control
- Backlighting
- DC-DC Converters
- Power Management Functions

Features

- Low Input Capacitance
- High BV_{DSS} Rating for Power Application
- Low Input/Output Leakage
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

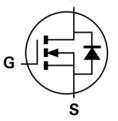
Mechanical Data

- Case: TO220AB
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Terminals: Matte Tin Finish Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208[®]
- Terminal Connections: See Diagram Below
- Weight: TO220AB 1.85 grams (Approximate)

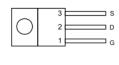
TO220AB







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Top View

Bottom View

Equivalent Circuit

Top View Pin Out Configuration

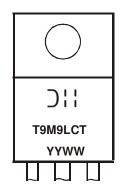
Ordering Information (Note 4)

	Part Number	Case	Packaging
١	DMT10H9M9LCT	TO220AB	50 Pieces/Tube

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



Temperature of the state of the



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V _{DSS}	100	V	
Gate-Source Voltage	V_{GSS}	±20	V	
Continuous Drain Current (Note 6) $V_{GS} = 10V$ $T_{C} = +25^{\circ}C$ $T_{C} = +70^{\circ}C$		I _D	101 80	А
Maximum Continuous Body Diode Forward Current (Note 6)	ls	101	Α	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	404	Α	
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%	Ism	404	Α	
Avalanche Current, L = 0.3mH (Note 8)	las	21	Α	
Avalanche Energy, L = 0.3mH (Note 8)	Eas	66	mJ	

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	2.3	W
Thermal Resistance, Junction to Ambient (Note 5)		Reja	54	°C/W
Total Power Dissipation	Tc = +25°C	PD	156	W
Thermal Resistance, Junction to Case (Note 7)		Rejc	0.8	°C/W
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C

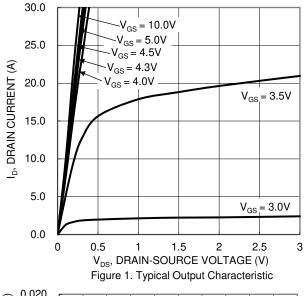
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage	BV _{DSS}	100		_	V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS	_	1	1	μΑ	$V_{DS} = 80V$, $V_{GS} = 0V$	
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	V _{GS(TH)}	1.3		2.5	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	D	_	6.7	8.5	mΩ	V _{GS} = 10V, I _D = 20A	
Static Drain-Source On-nesistance	R _{DS(ON)}	_	9.0	14	11177	$V_{GS} = 4.5V, I_{D} = 5A$	
Diode Forward Voltage	V _{SD}	_	0.8	1.2	V	V _G S = 0V, I _S = 13A	
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	Ciss	_	2309	_	pF	V _{DS} = 50V, V _{GS} = 0V f = 1MHz	
Output Capacitance	Coss		536				
Reverse Transfer Capacitance	Crss	_	15.7	_		1 = 1101112	
Gate Resistance	R_g	_	1.9	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Qg	_	40.2	_		V _{DD} = 50V, I _D = 13A, V _{GS} = 10V	
Gate-Source Charge	Qgs	_	20.2	_	nC		
Gate-Drain Charge	Q_{gd}	_	7.0	_			
Turn-On Delay Time	td(on)	_	8.5	_		$V_{DD} = 50V, V_{GS} = 10V,$ $I_{D} = 13A, R_{g} = 6\Omega$	
Turn-On Rise Time	tr	_	5.4	_			
Turn-Off Delay Time	tD(OFF)	_	10.6	_	ns		
Turn-Off Fall Time	tF	_	28.3	_			
Reverse Recovery Time	t _{RR}	_	14.9	_	ns	1 104 11/14 1004/	
Reverse Recovery Charge	Qrr	_	44.3	_	nC	I _F = 13A, di/dt = 100A/μs	

Notes:

- 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
- 7. Thermal resistance from junction to soldering point (on the exposed drain pad).
- 8. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_J = +25°C.
 9. Short duration pulse test used to minimize self-heating effect.
 10. Guaranteed by design. Not subject to product testing.





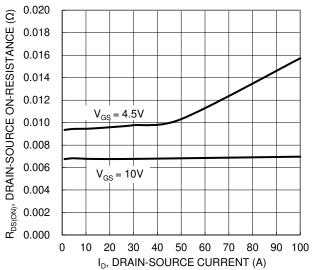


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

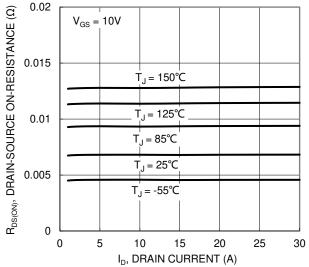
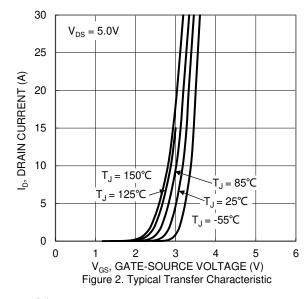
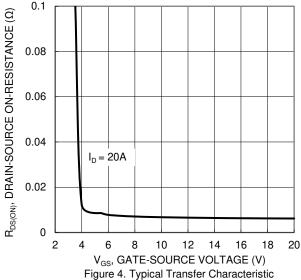


Figure 5. Typical On-Resistance vs. Drain Current and Temperature





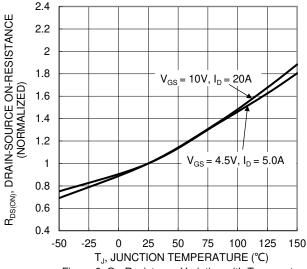
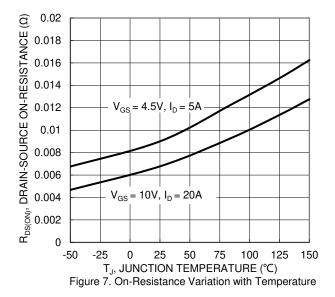
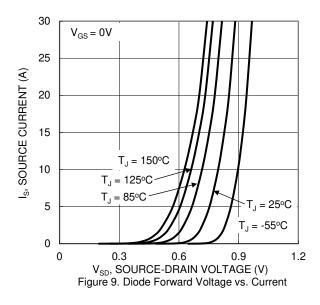


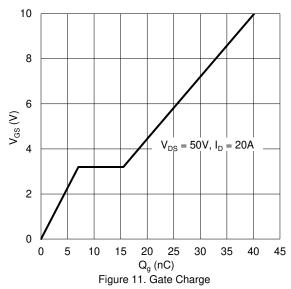
Figure 6. On-Resistance Variation with Temperature

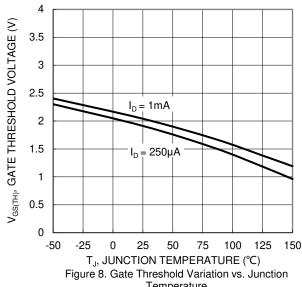




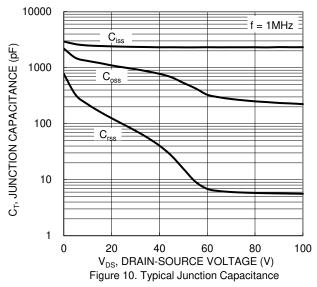


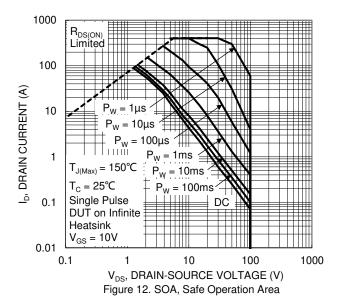






Temperature







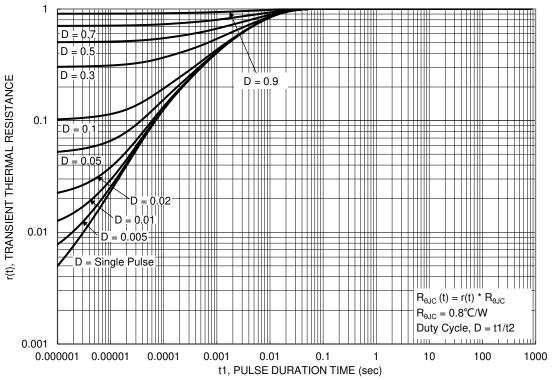


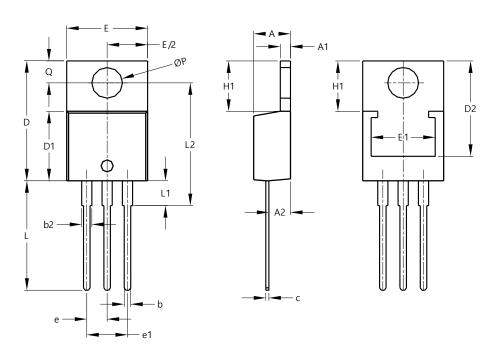
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

TO220AB



TO220AB						
Dim	im Min Max		Тур			
Α	3.56	4.82	_			
A 1	0.51	1.39				
A2	2.04	2.92				
b	0.39	1.01	0.81			
b2	1.15	1.77	1.24			
С	0.356	0.61				
D	14.22	16.51				
D1	8.39	9.01				
D2	11.45	12.87	_			
е	_	-	2.54			
e1			5.08			
Ε	9.66	10.66	_			
E1	6.86	8.89	_			
H1	5.85	6.85	_			
L	L 12.70 14.73		_			
L1	_	4.42	_			
L2	15.80	17.51	16.00			
Р	3.54	4.08				
Q	2.54	3.42	_			
All Dimensions in mm						



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DMT10H9M9LCT June 2021 www.diodes.com © Diodes Incorporated Document number: DS43274 Rev. 3 - 2